



富捷科技

Product Datasheet

产品规格说明书

FRL Series General

Low-ohmic Thick Film Chip Resistor

常规低阻厚膜片式电阻器

安徽省富捷电子科技有限公司

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普通低阻厚膜片式电阻器 General Low-ohmic Thick Film Chip Resistor



特点 (Features)

- 体积小, 重量轻 - Miniature and light weight
- 电性能稳定, 可靠度高 - Stable electrical capability and high Reliability
- 符合 RoHS 指令要求 - Compliant with RoHS directive
- 符合无卤素要求 - Halogen free requirement
- 低阻值 - Low-ohmic

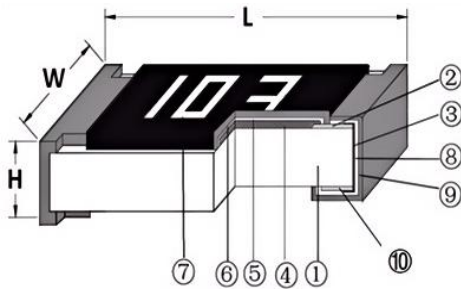
应用 (Application)

- 开关电源、音响设备的过电流保护、电压调节器、电源转换器、充电器、灯驱动电源、便携式设备等。
- Switching Power Supply, Over Current Protection in Audio Application, Voltage Regulation, Module(VRM), DC-DC Converter, Charger, LED Lamp Devices, Portable Devices, etc

产品料号 (Parts Number Explanation) 示例: FRL1206FR100TS

F 公司	RL 产品别	1206 尺寸	F 公差	R100 字码	T 包装别	S 端电极	特殊码
FOJAN	RL: General	0402	F:±1%	0603:3-digits	T: 7 inch reel	S: Sn	Blank:
	Low-ohmic	0603	J:±5%	R10=100mR	Q:10 inch reel	C: Cu	none
	Others series refer to Catalogue	0805		R50=500mR	R:13 inch reel	A: Au	
		1206		02Z=102mR	B: Bulk		
		1210		0805-2512:			
		1218		4-digits			
		1812		R100=100mR			
		2010		R500=500mR			
		2512					
Company	Product Type	Size	Tolerance	Resistance	Packaging	Termination	Special Case

■ 电阻结构 (Construction)

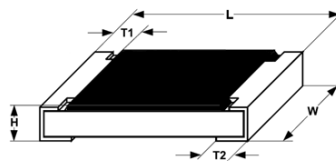


NO.	结构 Construction	主要材料 Major material
1	陶瓷基板 Ceramic substrate	三氧化二铝 Al_2O_3
2	银电极 Conductive layer (Top)	银 Ag
3	侧电极 Side conductive layer	镍铬合金 NiCr
4	阻体层 Resistive layer	氧化钌 RuO_2
5	内保护层 Inner protective layer	玻璃 Glass
6	外保护层 Outer Protective layer	环氧树脂 Epoxy
7	文字 Marking	环氧树脂 Epoxy
8	镍电极 Ni plating layer	镍 Ni
9	锡电极 Ni plating layer	锡 Ni
10	银电极 Conductive layer (Back)	银 Ag

■ 尺寸 (Dimension):

型别 (Type)		L	W	H	T1	T2
英制	公制					
0402	1005	1.00 ± 0.05	0.50 ± 0.05	0.35 ± 0.05	0.20 ± 0.10	0.25 ± 0.10
0603	1608	1.60 ± 0.10	0.80 ± 0.10	0.45 ± 0.10	0.25 ± 0.15	0.25 ± 0.15
0805	2012	2.00 ± 0.10	1.25 ± 0.10	0.50 ± 0.10	0.35 ± 0.20	0.40 ± 0.20
1206	3216	3.10 ± 0.10	1.60 ± 0.10	0.55 ± 0.10	0.45 ± 0.20	0.45 ± 0.20
1210	3225	3.10 ± 0.10	2.50 ± 0.15	0.55 ± 0.10	0.45 ± 0.15	0.50 ± 0.20
1218	3245	3.10 ± 0.10	4.60 ± 0.10	0.55 ± 0.10	0.45 ± 0.20	0.40 ± 0.20
1812	4532	4.50 ± 0.20	3.10 ± 0.20	0.55 ± 0.10	0.55 ± 0.20	0.70 ± 0.20
2010	5025	5.00 ± 0.10	2.50 ± 0.15	0.55 ± 0.10	0.45 ± 0.15	0.50 ± 0.20
2512	6432	6.35 ± 0.10	3.10 ± 0.15	0.55 ± 0.10	0.60 ± 0.20	0.90 ± 0.20

尺寸 Dimension



单位 (unit) : mm

■ 电气特性 (Electrical characteristics)

型别 Type	70°C 下额定功率 Rated Power at 70°C	最大工作电流 Max Working Current	最大过负荷电流 Max Overload Current	绝缘耐压 Dielectric Withstanding Voltage
0402	1/16W	0.79A	1.97A	300V
0603	1/10W	2.23A	5.59A	300V
0805	1/8W	2.50A	6.25A	500V
1206	1/4W	3.53A	8.83A	500V
1210	1/2W	5.00A	12.50A	500V
1812	3/4W	6.12A	15.30A	500V
2010	3/4W	6.12A	15.30A	500V
2512	1W	7.07A	17.67A	500V

备注 (Remark) : 额定电压计算公式 (The rated voltage is calculated by the following formula) :

$$E = \sqrt{RP}$$

E: 额定电压 (Rated Voltage) (V)

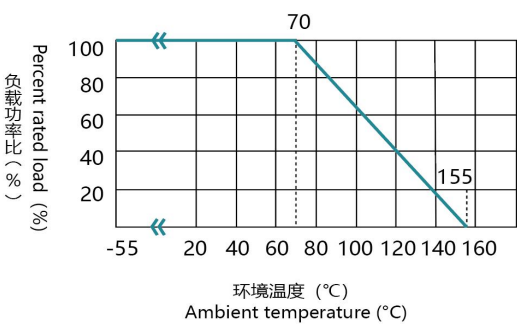
P: 额定功率 (Rated Power) (W)

R: 电阻阻值 (Resistance) (ohm)

如果计算出的电压超过此型别的最大工作电压, 则此型别的最大工作电压为此电阻的额定电压。

In case the value calculated by the formula exceed the maximum working voltage as above table 8, the maximum working voltage shall be regarded as rated voltage.

■ 功率衰减曲线 (Derating Curve)

使用温度范围 Temperature usage range	-55°C~+155°C
说明 Describe	周围温度若超过 70°C 至 155°C 之间, 功率可照下图曲线予以修订 If the ambient temperature exceeds 70°C to 155°C, the power can be revised according to the curve in the following figure
功率衰减曲线图 Power Attenuation Curve	 <p>The graph shows the power attenuation curve. The y-axis is 'Percent rated load (%)' ranging from 0 to 100. The x-axis is 'Ambient temperature (°C)' ranging from -55 to 160. The curve is constant at 100% for temperatures up to 70°C. At 70°C, the power begins to decrease linearly, reaching 0% at 155°C. Dotted lines indicate the points (70, 100) and (155, 0) on the curve.</p>

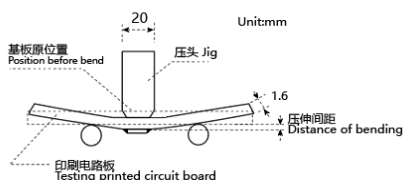
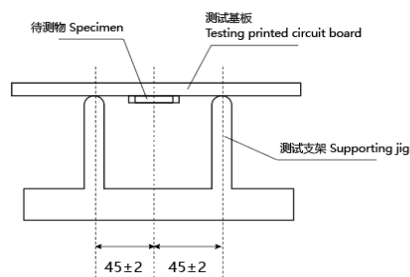
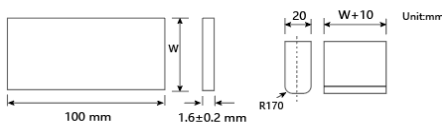
■ 温度系数 (Temperature Coefficient)

型别 Type	阻值范围 Resistance Range	产品精度和温漂系数 (ppm/°C) Resistance Tolerance and TCR(ppm/°C)		
		±1%	±2%	±5%
0402	$0.1\Omega \leq R < 0.5\Omega$	±800	±800	±800
	$0.5\Omega \leq R < 0.91\Omega$	±400	±400	±400
0603/0805 1206/1210 1812/2010/2512	$0.05\Omega \leq R < 0.1\Omega$	±1200	±1200	±1200
	$0.1\Omega \leq R < 0.5\Omega$	±800	±800	±800
	$0.5\Omega \leq R < 0.91\Omega$	±400	±400	±400

■ 性能 (Performance)

内容 Item	测试方法 Test Methods	测试条件 Test Conditions	规格 Specification
温度系数 Temperature Coefficient	JIS C 5201 4.8	$TCR = (R - R_0) / (t - t_0) R_0 \times 10^6 \text{ppm}$ R0: 电阻在室温下的阻值 (resistance at room temperature) R: 电阻在 125°C或-55°C下的阻值 (resistance at 125°C or -55°C) t0: 室温 (room temperature) t: 测试温度 (test temperature 125°C or -55°C)	As SEPC
短时间过负荷 Short-time overload	JIS C 5201 4.13	加载 2.5 倍的额定电压, 时间 5 秒后测量试验前后的阻值变化率。 Applied 2.5 times of rated Voltage for 5 second. Measure the variation of resistance.	0.5%/1%:±(1.0%+0.05Ω) 5%:±(2.0%+0.05Ω)
焊锡性 Solderability	JIS C 5201 4.17	沾助焊剂后浸入锡炉, 锡炉温度 245±5°C, 时间 3 ±0.5 秒。 Dip the terminal in a flux and then dip into a soldering bath at 245±5°C for 3±0.5sec.	> 95%面积上锡 (>95% coverage)
抗焊锡热 Resist to soldering heat	JIS C 5201 4.18	沾助焊剂后浸入锡炉, 锡炉温度 260±5°C, 时间 10±0.5 秒, 测量试验前后的阻值变化率。 Dip the terminal in a flux and then dip into a soldering bath at 260±5°C for 10±0.5sec. Measure the variation of resistance.	±(1.00% +0.05Ω)
绝缘电阻 Insulation resistance	JIS C 5201 4.6	电阻本体上加载绝缘耐压 60±5 秒后, 测量绝缘阻抗。 Applied the dielectric withstanding voltage on the center of body for 60±5seconds. Then measure insulation resistance.	> 10GΩ
绝缘耐压 Dielectric withstanding voltage	JIS C 5201 4.7	电阻本体上加载绝缘耐压 60±5 秒。 Applied the dielectric withstanding voltage on the center of body for 60±5seconds.	无击穿、飞弧可见机械性损伤 No evidence of flashover, mechanical damage arcing or insulation breakdown

内容 Item	测试方法 Test Methods	测试条件 Test Conditions	规格 Specification
温度快速变化 Rapid temperature changes	JIS C 5201 4.19	电阻放入温度循环机中, T1 温度: $-55\pm 3^{\circ}\text{C}$; T2 温度: $155\pm 3^{\circ}\text{C}$. $125\pm 3^{\circ}\text{C}$, 放置 30 分钟, 共 300 个循环。量测试验前后阻值变化率。 Put specimen in a chamber which temperature can be T1: $-55\pm 3^{\circ}\text{C}$; T2: $155\pm 3^{\circ}\text{C}/125\pm 3^{\circ}\text{C}$, 30min, repeated 300 cycles. Measure the variation of resistance.	$0.5\%/1\%:\pm(1.0\%+0.05\Omega)$ $5\%:\pm(2.0\%+0.05\Omega)$
温湿循环 Moisture resistance	MIL-STD-202 METHOD 106	$25^{\circ}\text{C}\sim 65^{\circ}\text{C}$, $90\%\sim 100\%\text{RH}$, 2.5 小时; 65°C $90\%\sim 100\%\text{RH}$, 3 小时; $65^{\circ}\text{C}\sim 25^{\circ}\text{C}$, $80\%\sim 100\%\text{RH}$,2.5 小时, 10 个循环, 试验结束 24 ± 4 小时后进行测试。 $25^{\circ}\text{C}\sim 65^{\circ}\text{C}$, $90\%\sim 100\%\text{RH}$, 2.5H; 65°C $90\%\sim 100\%\text{RH}$, 3H; $65^{\circ}\text{C}\sim 25^{\circ}\text{C}$ $80\%\sim 100\%\text{RH}$, 2.5H, 10 cycles, Measurement at 24 ± 4 hours after test conclusion.	$0.5\%/1\%:\pm(1.0\%+0.05\Omega)$ $5\%:\pm(2.0\%+0.05\Omega)$
端子弯曲 Terminal bending	JIS C 5201 4.33	电阻焊接在测试板上进行弯折, 弯折保持时间 20 ± 1 秒, 1206 (含) 以下的尺寸弯曲 $5+0.2/0$ mm; 1206 以上的尺寸弯曲 $2+0.2/0$ mm; 量测试验前后阻值变化率 Specimen shall be mounted on test board, then bend the board and maintained for 20 ± 1 s. the distance of bending is $5+0.2/0$ mm for resistors which size no larger than 1206 or $2+0.2/0$ mm which size larger than 1206. Measure the variation of resistance. 测试板 (test board) 压头 (jig)	$\pm(1.00\% + 0.05\Omega)$



内容 Item	测试方法 Test Methods	测试条件 Test Conditions	规格 Specification
耐湿特性 Humidity	JIS C 5201 4.24	电阻放入恒温恒湿箱, 温度 $40\pm 2^{\circ}\text{C}$, 湿度 $90\sim 95\% \text{RH}$; 通电额定电压 1.5 小时, 断电 0.5 小时; 重复通断电至试验时间 $1000^{+48}/_{-0}$ 小时。量测试验前后阻值变化率。 Put the specimen in a chamber at $40\pm 2^{\circ}\text{C}$ temperature and $90\% \sim 95\%$ relative humidity, then applied rated voltage for 1.5H "ON" and 0.5H "OFF" repeatedly till total test time is $1000^{+48}/_{-0}$ H. Measure the variation of resistance.	0.5%、1%: $\pm(1.0\%+0.05\Omega)$ 5%: $\pm(2.0\%+0.05\Omega)$
负荷寿命 Load life	JIS C 5201 4.25.1	电阻放入恒温箱中, 温度 $70\pm 2^{\circ}\text{C}$, ON TIME:1.5H, OFF TIME:0.5H, 通电额定电压 $1000^{+24}/_{-0}$ 小时, 量测试验前后阻值变化率。 Put the specimen in a chamber at $70\pm 2^{\circ}\text{C}$ temperature, ON TIME:1.5H, OFF TIME:0.5H, and applied rated voltage for $1000^{+24}/_{-0}$ H. Measure the variation of resistance.	0.5%、1%: $\pm(1.0\%+0.05\Omega)$ 5%: $\pm(2.0\%+0.05\Omega)$

■ 本体标识 (Marking on the Resistor's Body)

1.0402 因本体太小, 本体上无字码标识

For 0402 size, no marking on the body due to the small size of the resistor

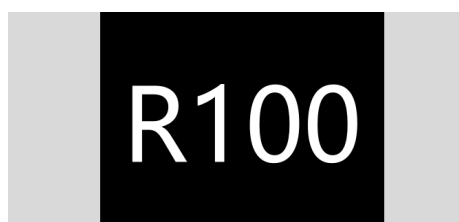
2.0603 规格 (1%&5%) (0603Type) : 3 字码 (3-digits)



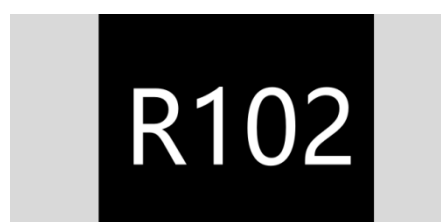
R10=100mΩ

3.0805/1206/1210/2010/2512/1812 规格 (1%&5%) : 4 字码

0805/1206/1210/2010/2512/1812type(1%&5%):4-digits



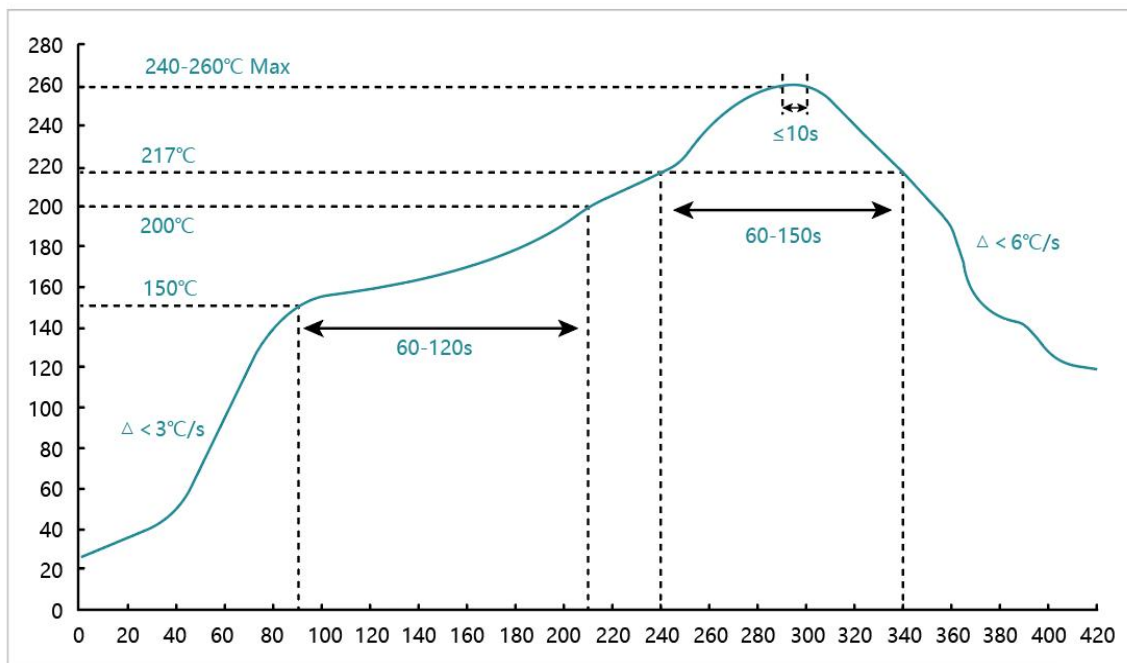
R100=100mΩ



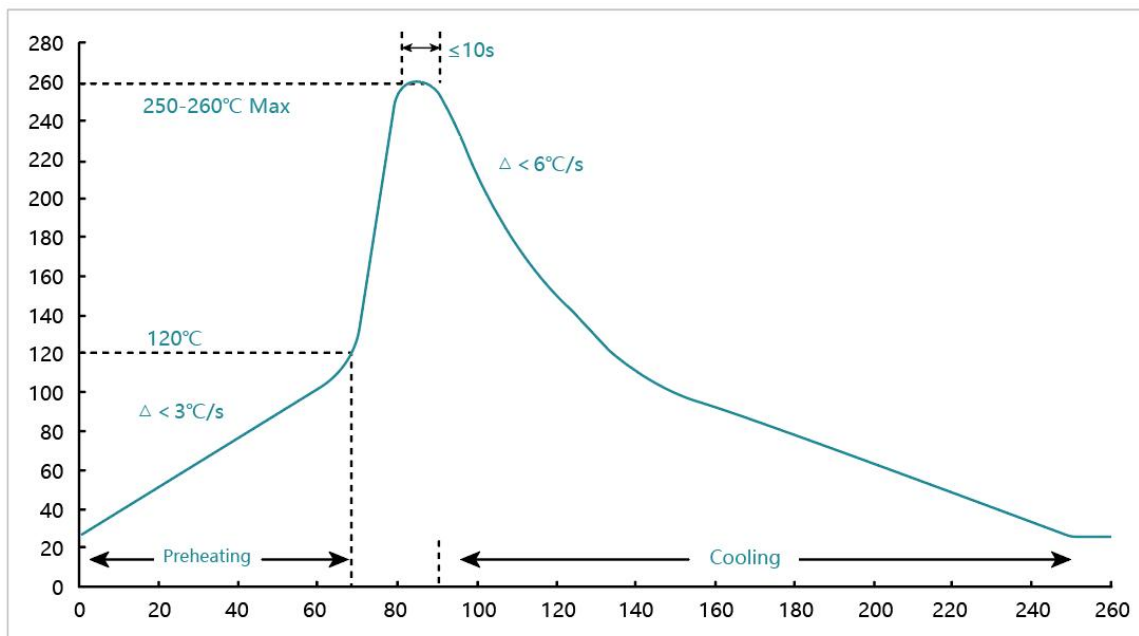
R102=102mΩ

■ 焊接 (soldering)

- 建议回流焊曲线 (Recommend reflow soldering profile)



- 建议波峰焊曲线 (Recommend wave soldering profile)



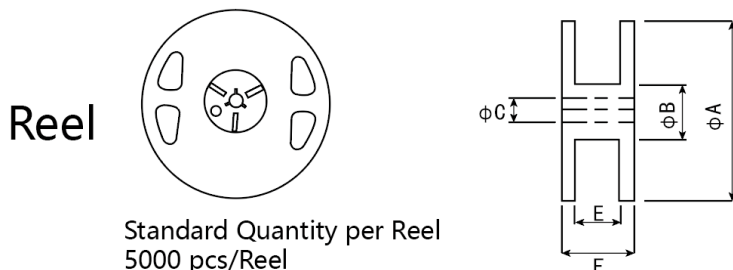
- 手工焊温度 (hand soldering temperature)

烙铁温度 $350 \pm 10^{\circ}\text{C}$ 3 秒之内, 避免烙铁接触电阻本体

The iron temperature is $350 \pm 10^{\circ}\text{C}$, hand soldering time less than 3S. Avoid solder iron tip direct touch the components body

■ 包装规格 (Tapping Specification)

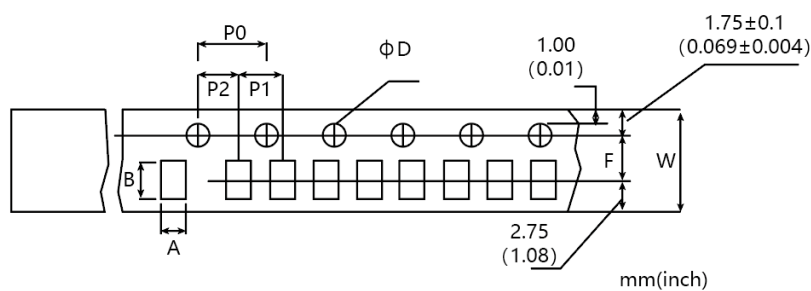
- 卷盘尺寸 (Reel dimension)



Type	Size	Unit	A	B	C	F	W	
0402	7"	10K/Reel	mm	178±2.0	60.0±1.0	13.5±0.5	11.4±0.1	9.00±0.3
0402	13"	40K/50K Reel	mm	330±2.0	100.0±1.0	13.5±0.5	11.4±0.1	9.00±0.3
0603/0805/1206/1210	7"	5K/Reel	mm	178±2.0	60.0±1.0	13.5±0.5	11.4±0.1	9.00±0.3
0603/0805/1206	10"	10K/Reel	mm	254±2.0	100.0±1.0	13.5±0.5	11.4±0.1	9.00±0.3
0603/0805/1206	13"	20K/Reel	mm	330±2.0	100.0±1.0	13.5±0.5	11.4±0.1	9.00±0.3
1218/1812/2010/2512	7"	4K/Reel	mm	178±2.0	60.0±1.0	13.5±0.5	15.4±1.0	13.0±0.3

-包装尺寸 (packing dimension)

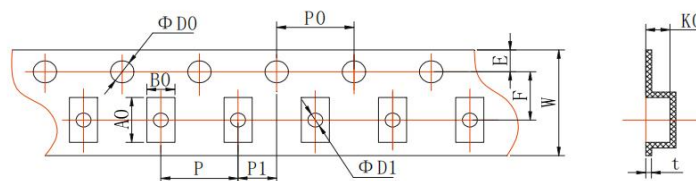
纸带编带 Paper Taping



Unit: mm

Dim	A	B	D	F	P0	P1	P2	W	T
0402	0.65±0.10	1.15±0.10	1.50±0.10	3.50±0.05	4.00±0.10	2.00±0.10	2.00±0.05	8.00±0.20	0.42±0.03
0603	1.10±0.10	1.90±0.10	1.50±0.10	3.50±0.05	4.00±0.10	4.00±0.10	2.00±0.05	8.00±0.20	0.60±0.03
0805	1.65±0.20	2.40±0.20	1.50±0.10	3.50±0.05	4.00±0.10	4.00±0.10	2.00±0.05	8.00±0.20	0.75±0.05
1206	1.90±0.20	3.50±0.20	1.50±0.10	3.50±0.05	4.00±0.10	4.00±0.10	2.00±0.05	8.00±0.20	0.75±0.05
1210	2.80±0.20	3.50±0.20	1.50±0.10	3.50±0.05	4.00±0.10	4.00±0.10	2.00±0.05	8.00±0.20	0.75±0.05

塑料带编带 Embossed Taping



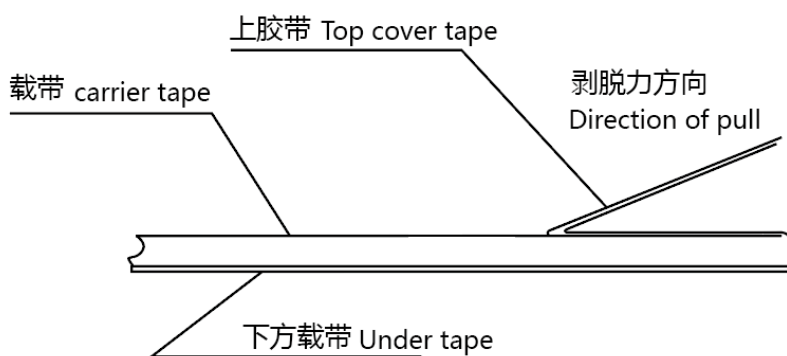
Unit: mm

Dim	B0	A0	D0	F	P0	P	P1	W	K0
1218	2.80±0.20	4.60±0.20	1.50±0.10	5.50±0.05	4.00±0.10	4.00±0.10	2.00±0.05	12.0±0.10	0.75±0.10
1812	3.52±0.10	5.10±0.10	1.50±0.10	5.50±0.05	4.00±0.10	4.00±0.10	2.00±0.05	12.0±0.10	0.78±0.10
2010	2.75±0.10	5.40±0.10	1.50±0.10	5.50±0.05	4.00±0.10	4.00±0.10	2.00±0.05	12.0±0.10	0.75±0.10
2512	3.35±0.10	6.70±0.10	1.50±0.10	5.50±0.05	4.00±0.10	4.00±0.10	2.00±0.05	12.0±0.10	0.75±0.10

■ 上胶带剥离力测试 (Peel force of top cover tape)

上胶带以 200mm/分钟的速度，沿 165~180 度角的方向进行剥离，如下图所示。纸带的剥离力范围为 10g~70g；载带的剥离力范围 30~100g。

The top cover tape is pulled at a speed of 200 mm/min with the angle between the tape during peel and the direction of unreeling maintained at 165 to 180 degree as following picture. The peel force of paper carrier tape shall be 0.1N to 0.7N(10 to 70 g), the peel force of plastic carrier tape shall be 0.3N to 1N (30 to 100 g)



■ 厚膜电阻器使用说明 (Chip Resistor Instructions for use)

本产品以下特殊环境下应用，性能可能会受到影响：

(Application of the products in a special environment can deteriorate product performance):

1. 高温；
High temperature
2. 有海风或腐蚀性气体，包括氯气，硫化氢，氨气，二氧化硫，二氧化氮等；
Near the sea ,or corrosive gas, such as Cl_2, H_2S, NH_3, SO_2 and NO_2 etc;
3. 各种类型的液体，包括水，油，化学品，有机溶剂的使用；
Unverified liquids, such as water,oil,chenical or organic solvent;
4. 在用树脂或其他涂层材料密封产品的情况下使用；
Unverified resin or paint to cover products;
5. 焊接后使用不洁焊剂或使用水或水溶性清洁剂清洗产品
Products should be washed with soluble cheaner even if non cleaning flux.

- 储存 / 搬运条件 (Storage / Carry conditions)

1. 储存温度 $25\pm 5^{\circ}C$ Temperature: $25\pm 5^{\circ}C$
2. 湿度 30%~70%RH Humidity: 30%~70%RH
3. 储存期限：先进先出，2年 Storage life: 2years FIFO
4. 存放和搬运时，请保持盒子的正确方向。严禁跌落在箱体上，否则可能损坏产品电极或本体
Please hold box correct orientation when storing and carrying.It is strictly prohibited to fall on the box.
otherwise the product electrode or body may be damaged.

